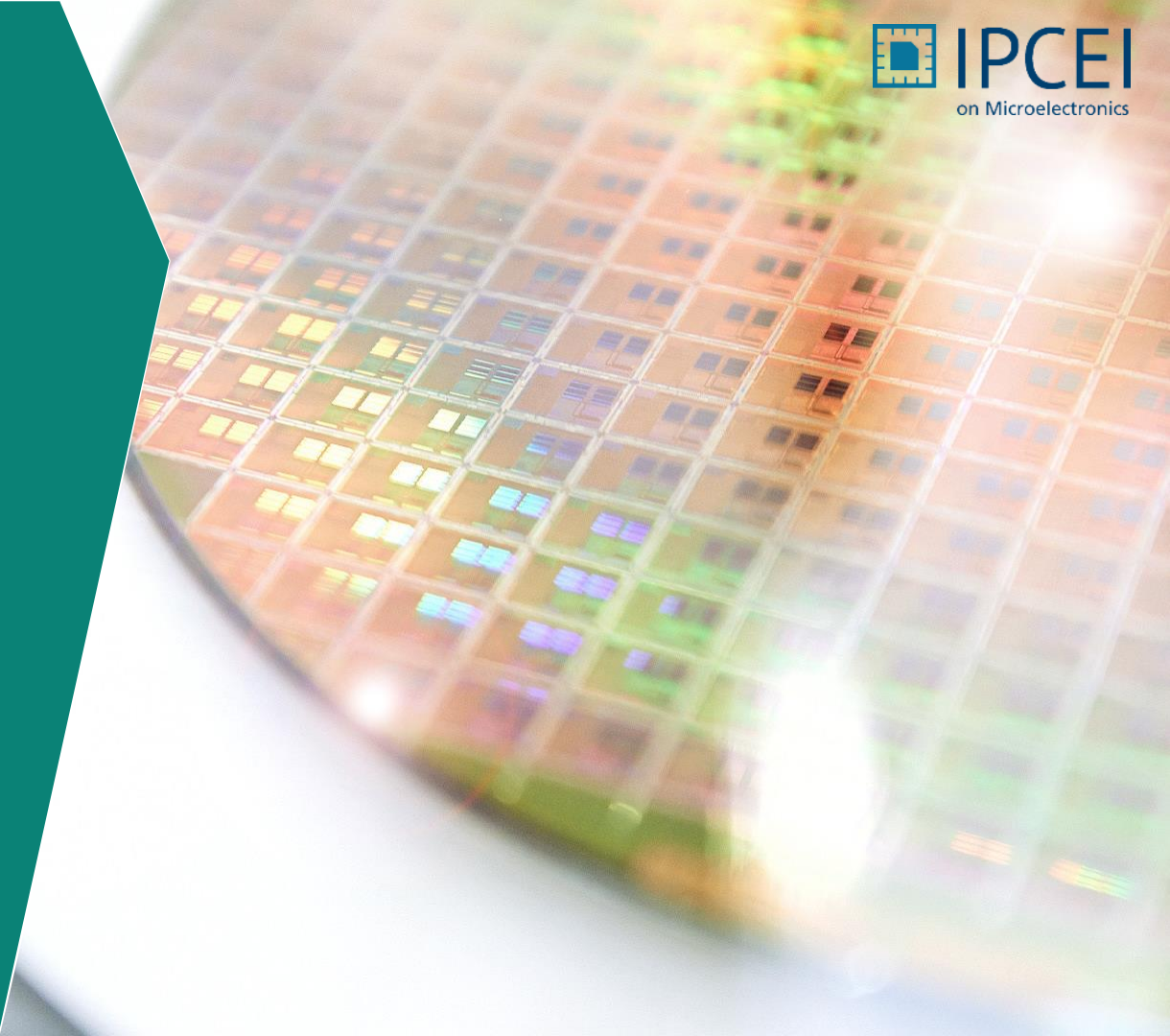




IPCEI Microelectronics



IPCEI Microelectronics



Semiconductors on the global geopolitics agenda



Chips are at the center of the global technological race. They are the bedrock of our modern economies and essential for the goods that we use on an everyday basis – we have them in our smartphones... Or now...with the energy topic, they are in the electric grids. So the chips are crucial in almost every device.”

**Ursula von der Leyen, President of the European Commission at the State of the Union
– European Chips Act, 8 February 2021**

“These chips, these wafers... It’s all infrastructure....We need to build the infrastructure of today, not repair the one of yesterday.”

**Joe Biden, President of the US at the CEO Summit on Semiconductors
– 12 April 2021**

Semiconductors on the global geopolitics agenda
















- Growing global demand for semiconductors due to accelerated pace of digitization and electrification
- The shortage of semiconductors has concrete consequences
- Accelerated investment across the world in microelectronics education, research and manufacturing to secure supply security, including the EU Chips Act.

IPCEI Microelectronics: partners and technology fields











Energy Efficient Chips

 CEA-Leti
 Cologne Chip
 Globalfoundries
 NXP Semiconductors Austria
 RaylCs
 Soitec
 ST Microelectronics
 X-FAB



Power Semiconductors

 3-D Micromac*
 AP&S International
 AT&S
 CEA-Leti
 Elmos Semiconductors
 Infineon
 Infineon Austria 
 MURATA
 Robert Bosch
 SEMIKRON
 ST Microelectronics
 X-FAB



Smart Sensors

 CEA-Leti
 <i>CorTec</i>
 Elmos Semiconductors
 Fondazione Bruno Kessler
 Infineon
 Robert Bosch
 ST Microelectronics
 TDK-Micronas
 LYRED
 X-FAB

Advanced Optical Equipment

 AMTC*
 Carl Zeiss

Compound Materials

 AZUR Space Solar Power
 CEA-Leti
 Integrated Compound Semiconductors
 IQE
 Newport Wafer Fab
 SPTS Technologies
 OSRAM
 SYNRED
 Soitec
 ST Microelectronics

Austrian consortium:



SMEs: in *“italic”*
Associated partners:*

IPCEI Microelectronics in a nutshell

Strategic European project

- Contributing to EU Green Deal and Technological Sovereignty
- 4 EU members states & UK, 30+ partners
- Approved in December 2018, Austria joined in March 2021

Funding

- Funding per national governments, approval by the EU Commission
- State aid instrument
- Activities beyond R&D are funded | First Industrial Deployment

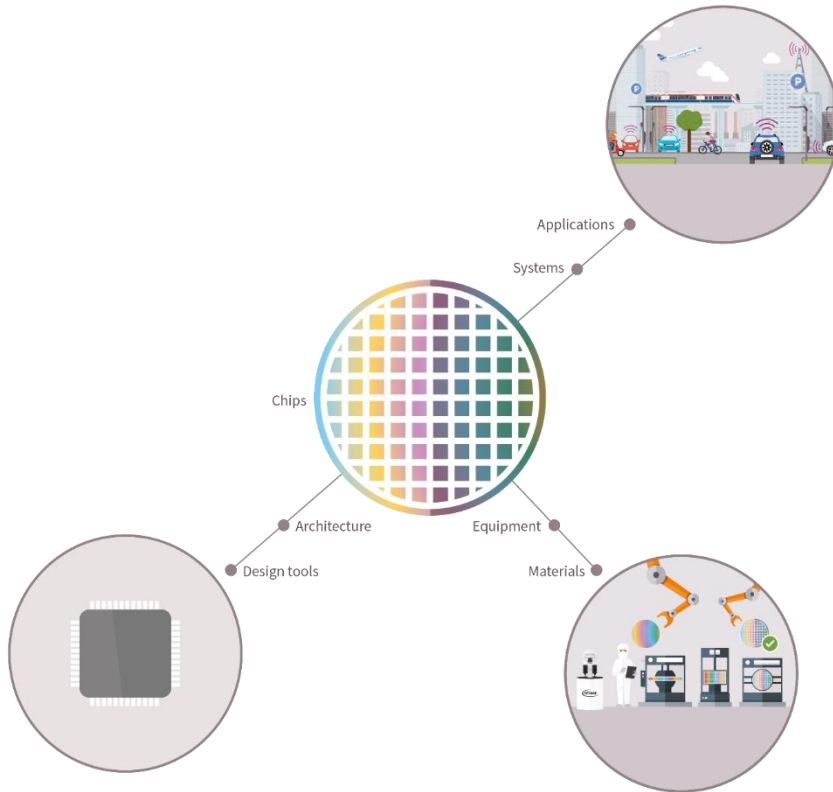
Technology fields

- Energy-efficient chips, power semiconductors, sensors, advanced optical equipment and compound materials

Positive spillover effects

- Knowledge generated will be disseminated via spillover activities
- Supporting EU STEM Talent and universities
- Spillover activities are not publicly funded

IPCEI: From R&D&I to First Industrial Deployment (FID)



Enabling strategic value chains in Europe

- Energy, automotive, smart manufacturing...

Building on pre-competitive research

- Complementing EU/national R&D&I funding, ECSEL JU, Eureka, *etc.*

First Industrial Deployment

- Stabilizing next generation products and processes

R&D&I

- Technology Development and First Industrial Deployment in
 - Energy Efficiency (Si, SiC, GaN)
 - Electro Mobility (Charging, Sensing)
 - TARGET: Bring innovative technologies „Made in Europe“ fast to volume production & to market



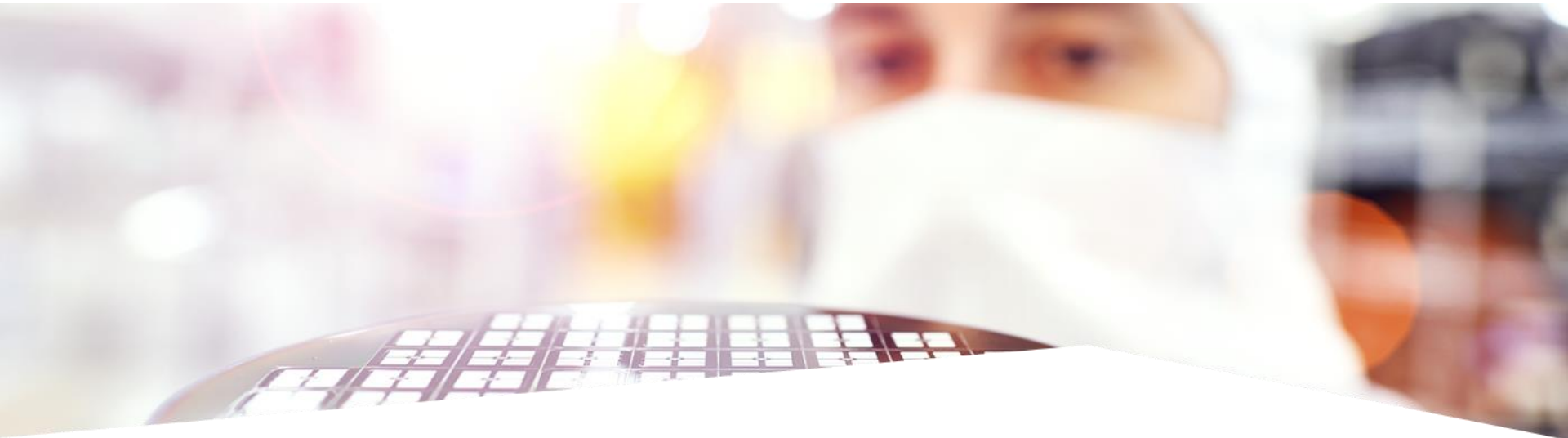
Spillover Activities

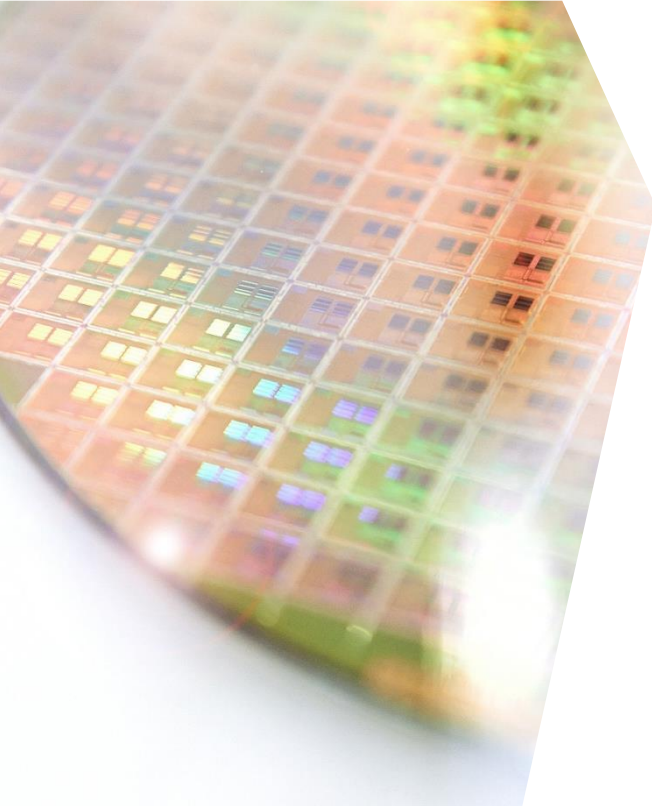
- Dissemination of R&D&I
- New collaborations with universities, STEM Talents and industry
- Focus on Eastern and Southeastern European countries
- TARGET: Strengthen cooperation Industry/Industry & Industry/Academia

Collaboration Projects

- With 12 Companies
 - Raw Wafer Engineering
 - Equipment & Process Innovation
 - Chip Embedding & Assembly Packaging

IPCEI on ME subtasks





- Silicon (Si)-based Technology in 100V
- Reliability of up to +75 times longer lifetime depending on the application
- Less heat production during operation
- More energy efficient than its predecessors
- Saves electricity consumption of 170 households within 1 year for telecom applications
(considering average yearly household energy consumption in EU)

OptiMOS 6™ 100V in your daily life



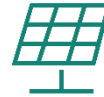
Telecom



eBike



Power tools



Solar

— OLED TV

Makes watching your favorite TV show more energy efficient.

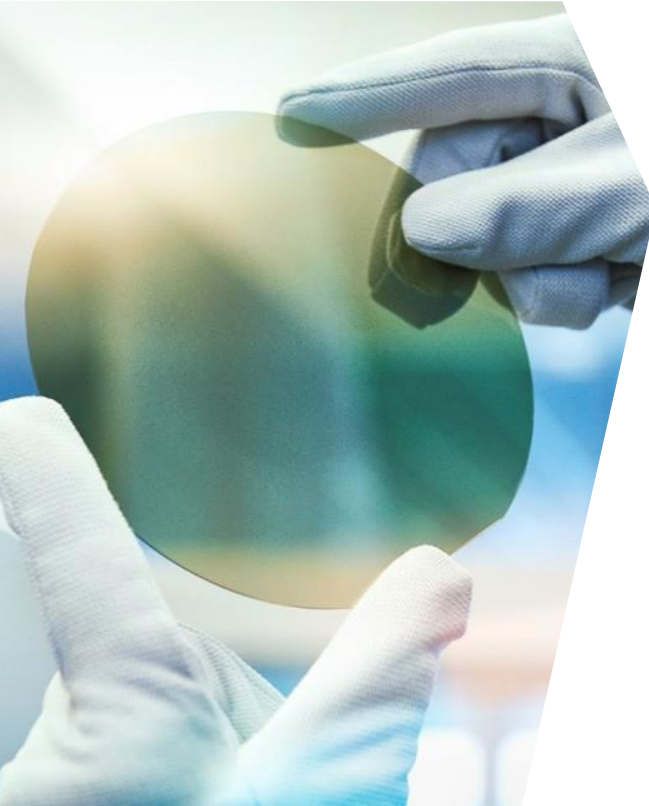


Wireless charging

— Wireless Charging

Cutting cables necessary for charging everything from smartphones and laptops to kitchen appliances and cars.





- Silicon carbide (SiC)
- Providing higher power levels in an extremely effective and efficient way
- Reliability of up to +75 longer lifetime
- System size reduction providing smaller products
- Infineon has expertise in SiC technology for over 20 years

CoolSiC™ in your daily life



UPS



Energy storage



EV charging



Renewables



Traction

– Traction

Highly efficient components that reduce energy losses in trains...



eMobility

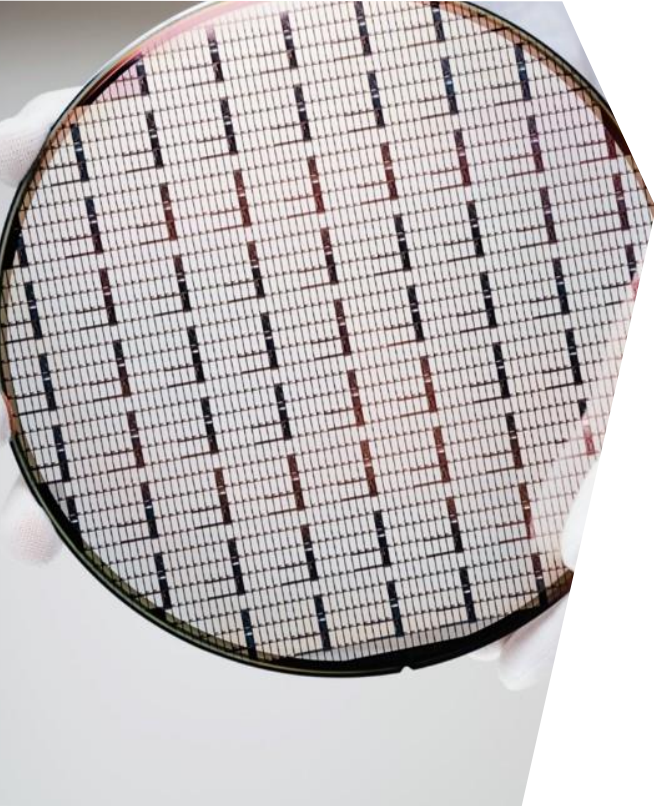
– eCars

... as well as in electric cars.
So you get more comfortable and greener to your destination!



GaN Technology

IPCEI on ME subtask

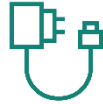


- Gallium nitride (GaN)
- Next-generation power semiconductors with a ten times lower carbon footprint
- Operates at higher voltages, temperatures and frequencies
- System size reduction providing smaller products
- Infineon's CoolGaN™ chips focus on high performance and robustness with lifetimes beyond 15 years

CoolGaN™ in your daily life



Wireless charging



Charger



Motor control



Server



Telecom

– Data and server center

CoolGaN™ products lead to:

- lower power consumption
- lower temperature while operation
→ reducing cooling affords of servers

- environmental friendly digitalization
Global Internet data traffic grew more than 40% in 2020 alone, while the energy consumption remains almost the same due to power electronics.



- Less fuel consumption due to increased generator efficiency up to 8%
- Qualification as eco-innovations, defined by the European Union
- CO2 emissions reduction of a car by up to 1.8 g/km



Alternators

– **Light vehicle generators**

In a conventional car, the generator produces the electric energy for charging the battery and supplying a growing number of safety and comfort features such as driver assistance systems, air conditioning and infotainment.





XENSIV™ tire pressure monitoring system (TPMS)

- Protects from tire failures which are caused by under-inflation and slow leaks
- Eliminates the need to manually check the air pressure
- Automatically issues a warning message on the display
- Correct tire pressure safes you fuel and therefore money
- Get to your destination, safer, greener and more comfortable
- Fast growing market: 2-wheelers (e-bikes/e-scooters)

Trapped ions enabling supercomputers of the future

- Accelerate the development of quantum computers
- Solve complex tasks faster and more efficient than today's computers
- Infineon has leading expertise in this research field, taking ion traps to the next level:
 - From prototypes to volume production
- Founding member of QUTAC, the Quantum Technology & Application Consortium





Trapped ions enabling supercomputers of the future

- In future quantum computers can make a significant contribution e.g. to:
 - Chemistry:
Research and faster development of polymers, a material used in every household
 - Logistics:
Optimizing route planning
 - Drug development:
Extensive laboratory experiments may be reduced in the future

FUTURE SMART Technology

IPCEI on ME subtask

- Energy-efficient functions in as little space as possible
- Smart switches increasing performance and reliability of your car's control unit, responsible for processing and communicating information



Lane assist

- **Driver assistance systems**
helps to enable CO2 reduction as well as driver assistance systems up to fully autonomous cars. So you feel more safe while driving to your destination.



Questions & answers



Acknowledgement



This work is funded by the Austrian Federal Ministry of Climate Action, Environment, Energy, Mobility, Innovation and Technology, the Austrian Federal Ministry of Digital and Economic Affairs, and implemented by austria wirtschaftsservice (aws) and the Austrian Research Promotion Agency (FFG)

in the frame of the

**Important Project of Common European Interest (IPCEI)
on Microelectronics.**

 **Federal Ministry**
Republic of Austria
Climate Action, Environment,
Energy, Mobility,
Innovation and Technology

 **Federal Ministry**
Republic of Austria
Digital and
Economic Affairs



The IPCEI on Microelectronics is also funded by Public Authorities from Germany, France, Italy and U.K.





Spillover activities

IPCEI investment in EU microelectronics R&D&I creates new opportunities

Unlocking nearly €8 billion new
public-private investment and
fueling the growth of European
microelectronics industry
(Source: EU Commission)



Jobs and skills

Raising new job opportunities
in the EU microelectronics
industry,
requiring advanced knowhow
and skills



Growth

Reinforcing collaborations with SMEs, startups, and large enterprises along the microelectronics value chain with downstream and upstream players



Innovation

Enabling new R&D
collaborations across Europe



Let's stay in contact!

Find out more about Infineon Austria
and IPCEI Microelectronics
www.infineon.com/ipceimeaustria or
send an email to
ipcei.me.austria@infineon.com

